

PSpice Model TVS STMicroelectronics SM30T10CAY



Model Information

Model A macro model based on general SPICE diode model

Call Name MDC_SM30T10CAY_PS

Pin Assign 1:A 2:A

File List Model Library MDC SM30T10CAY PS.lib

Model Report MDC SM30T10CAY PS.pdf(this file)

Verified Simulator Version PSpice version 17.4

Note

References

The information which was used for modeling is as follow:

[Data Sheet]

●Date/Version DS8599 - Rev 11 - March 2022

Product nameCompany nameSM30T10CAYSTMicroelectronics

[Characteristics listed]

● Characteristics IfVf[Temp], IrVbr[Temp], CjVr,

SurgeReverseCurrentWaveform

Simulation Range

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

Item	Range			Unit
	Min.		Max.	
Temperature	25	to	85	deg C





Diode

O:Implemented

× : Not Implemented

—: Not applicable

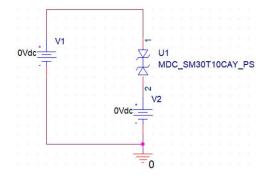
		— : Not applicable	
Model Functions Table	RANK=1		
Functions	RANK	Implemented	
IF-VF(Temp)	1	0	
IR-VBR(Temp)	1	0	
Capacitance	1	0	
Surge Reverse Current-Transient	1	0	



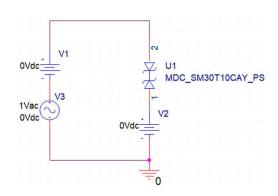
IrVbr[Temp], CjVr Testbench

Referred to Data Sheet

IrVbr[Temp]



CjVr



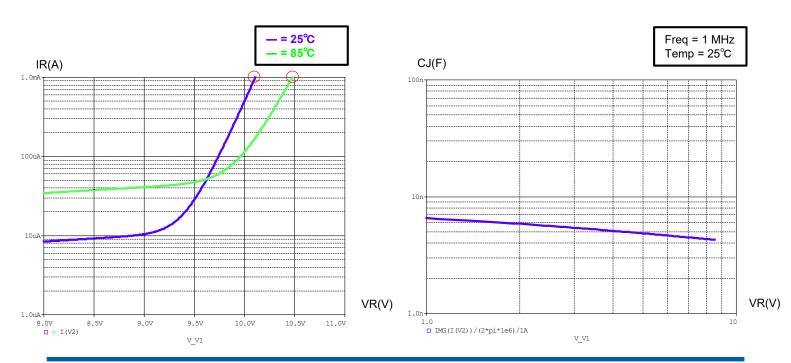
Simulation results are following.

Explanatory notes — : simulated

IrVbr[Temp]

(25°C) When IR=1mA, VBR \rightleftharpoons 10.1V (85°C) When IR=1mA, VBR \rightleftharpoons 10.5V

CjVr



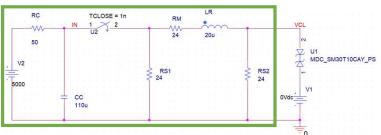


Surge Reverse Current Waveform Testbench

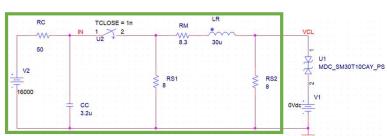
Referred to Data Sheet

Surge Reverse Current Waveform

10/1000 μs 8/20 μs



Current Pulse Generator



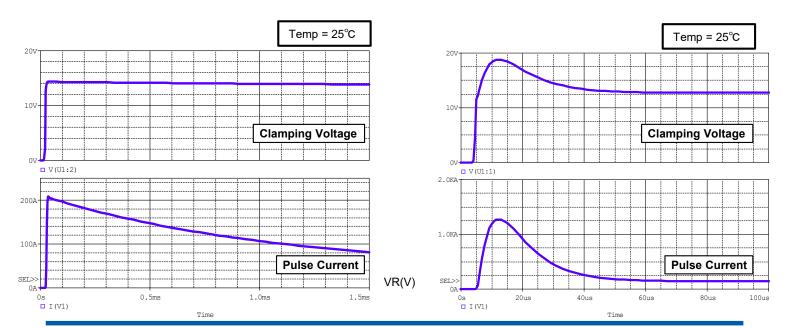
Current Pulse Generator

Simulation results are following.

Explanatory notes — : simulated

Surge Reverse Current Waveform

10/1000 μs 8/20 μs

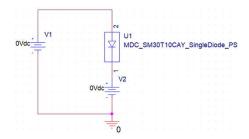




IfVf[Temp] Testbench

Referred to Data Sheet

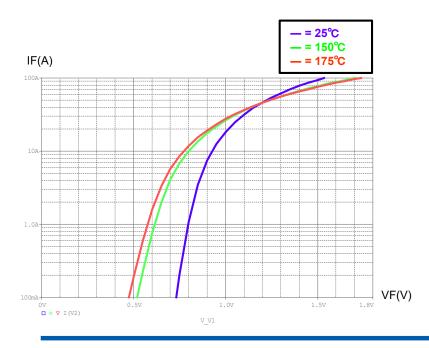
IfVf[Temp] for single diode



Simulation results are following.

Explanatory notes — : simulated

IfVf[Temp]





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MoDeCH Inc.

Head Office

Location: 5-15 Yokoyama-cho, Hachioji-Shi, Tokyo 192-0081, Japan

Tel:+81-42-656-3360

E-Mail:model-on-support@modech.co.jp

URL:http://www.modech.com/en/